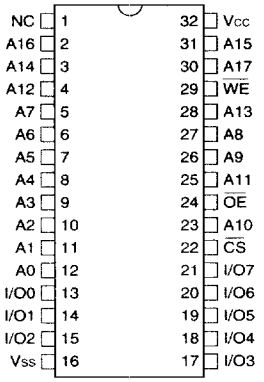
256Kx8 SRAM MODULE, SMD 5962-93157

FIG. 1

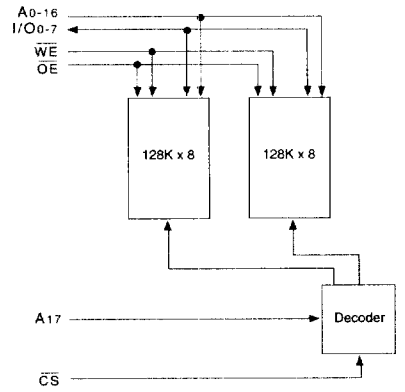
PIN CONFIGURATION TOP VIEW



PIN DESCRIPTION

A_{0-17}	Address Inputs
I/O_{0-7}	Data Input/Output
$\overline{CS}$	Chip Select
$\overline{OE}$	Output Enable
$\overline{WE}$	Write Enable
V_{CC}	+5.0V Power
V_{SS}	Ground

BLOCK DIAGRAM



FEATURES

- Access Times 55, 70, 85, 100, 120ns
- Standard Microcircuit Drawing, 5962-93157
- MIL-STD-883 Compliant Devices Available
- JEDEC Standard 32 pin, Hermetic Ceramic DIP (Package 300)
- Commercial, Industrial and Military Temperature Ranges
- Organized as 256K x 8
- 5 Volt Power Supply
- Low Power CMOS
- TTL Compatible Inputs and Outputs
- Battery Back-Up Operation

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T_A	-55	+125	°C
Storage Temperature	T_{STG}	-65	+150	°C
Signal Voltage Relative to GND	V_G	-0.5	Vcc+0.5	V
Junction Temperature	T_J		150	°C
Supply Voltage	V_{CC}	-0.5	7.0	V

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V_{CC}	4.5	5.5	V
Input High Voltage	V_{IH}	2.2	V_{CC} + 0.3	V
Input Low Voltage	V_{IL}	-0.5	+0.8	V
Operating Temp. (Mil.)	T_A	-55	+125	°C

TRUTH TABLE

$\overline{CS}$	$\overline{OE}$	$\overline{WE}$	Mode	Data I/O	Power
H	X	X	Standby	High Z	Standby
L	L	H	Read	Data Out	Active
L	X	L	Write	Data In	Active
L	H	H	Out Disable	High Z	Active

CAPACITANCE

(T_A = +25°C)

Parameter	Symbol	Condition	Max	Unit
Input capacitance	C_{IN}	V_{IN} = 0V, f = 1.0MHz	40	pF
Output capicitance	C_{OUT}	V_{OUT} = 0V, f = 1.0MHz	40	pF

This parameter is guaranteed by design but not tested.

4 SRAM MODULES

DC CHARACTERISTICS

(V_{CC} = 5.0V, V_{SS} = 0V, T_A = -55°C to +125°C)

Parameter	Sym	Conditions	-55		-70		-85		-100		-120		Units
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Input Leakage Current	I_{LI}	V_{CC} = 5.5, V_{IN} = GND to V_{CC}		10		10		10		10		10	µA
Output Leakage Current	I_{LO}	$\overline{CS}$ = V_{IH}, $\overline{OE}$ = V_{IH}, V_{OUT} = GND to V_{CC}		10		10		10		10		10	µA
Operating Supply Current	I_{CC}	$\overline{CS}$ = V_{IL}, $\overline{OE}$ = V_{IH}, f = 5MHz, V_{CC} = 5.5		130		90		80		70		70	mA
Standby Current	I_{SB}	$\overline{CS}$ = V_{IH}, $\overline{OE}$ = V_{IH}, f = 5MHz		50		30		2.5		1.5		1.5	mA
Output Low Voltage	V_{OL}	I_{OL} = 2.1mA, V_{CC} = 4.5		0.4		0.4		0.4		0.4		0.4	V
Output High Voltage	V_{OH}	I_{OH} = -1.0mA, V_{CC} = 4.5	2.4		2.4		2.4		2.4		2.4		V

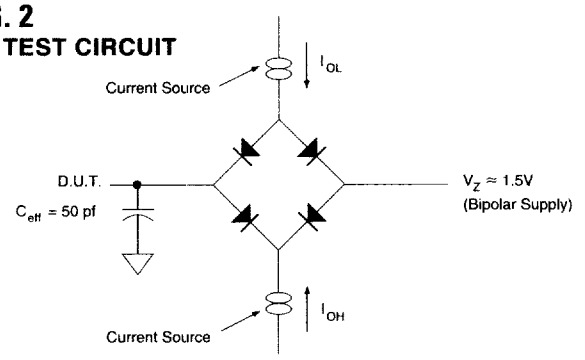
NOTE: DC test conditions: V_{IH} = V_{CC} -0.3V, V_{IL} = 0.3V

DATA RETENTION CHARACTERISTICS

(T_A = -55°C to +125°C)

Parameter	Symbol	Conditions	-55			-70			-85			-100			-120			Units
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Data Retention Supply Voltage	V_{DR}	$\overline{CS}$ ≥ V_{CC} -0.2V	2.0		5.5	2.0		5.5	2.0		5.5	2.0		5.5	2.0		5.5	V
Data Retention	I_{CCDR1}	V_{CC} = 3V		30	6400		30	2000		10	1000		10	1000		10	1000	µA

FIG. 2
AC TEST CIRCUIT



AC TEST CONDITIONS

Parameter	Typ	Unit
Input Pulse Levels	V_{IL} = 0, V_{IH} = 3.0	V
Input Rise and Fall	5	ns
Input and Output Reference Level	1.5	V
Output Timing Reference Level	1.5	V

NOTES:
Vz is programmable from -2V to +7V.
I_{OL} & I_{OH} programmable from 0 to 16mA.
Tester Impedance Z_0 = 75 Ω.
Vz is typically the midpoint of V_{OH} and V_{OL}.
I_{OL} & I_{OH} are adjusted to simulate a typical resistive load circuit.
ATE tester includes jig capacitance.

AC CHARACTERISTICS

(V_{CC} = 5.0V, V_{SS} = 0V, T_A = -55°C to +125°C)

Parameter Read Cycle	Symbol	-55		-70		-85		-100		-120		Units
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Read Cycle Time	t_{RC}	55		70		85		100		120		ns
Address Access Time	t_{AA}		55		70		85		100		120	ns
Output Hold from Address Change	t_{OH}	3		5		15		15		15		ns
Chip Select Access Time	t_{ACS}		55		70		85		100		120	ns
Output Enable to Output Valid	t_{OE}		40		50		55		60		60	ns
Chip Select to Output in Low Z	t_{CLZ}[1]	5		5		10		10		10		ns
Output Enable to Output in Low Z	t_{OLZ}[1]	0		5		5		5		5		ns
Chip Disable to Output in High Z	t_{CHZ}[1]		35		40		45		50		50	ns
Output Disable to Output in High Z	t_{OHZ}[1]		30		40		45		50		50	ns

1. This parameter is guaranteed by design but not tested.

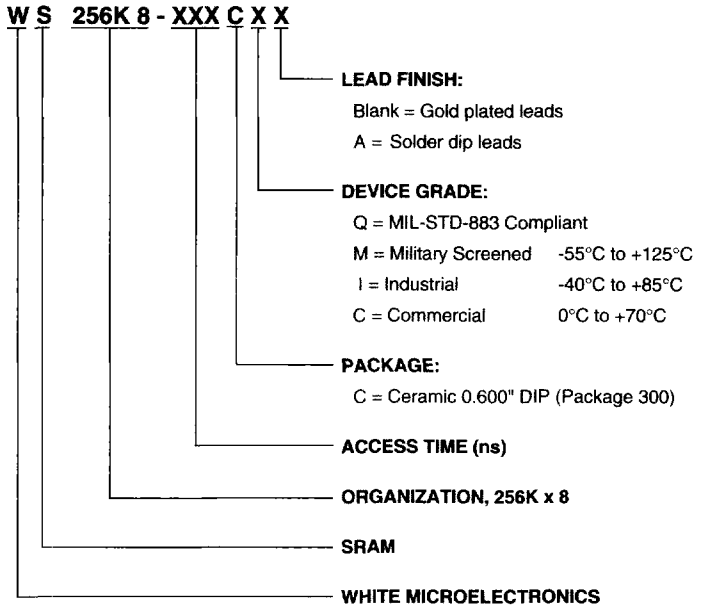
AC CHARACTERISTICS

(V_{CC} = 5.0V, V_{SS} = 0V, T_A = -55°C to +125°C)

Parameter Write Cycle	Symbol	-55		-70		-85		-100		-120		Units
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Write Cycle Time	t_{WC}	55		70		85		100		120		ns
Chip Select to End of Write	t_{CW}	45		65		80		90		110		ns
Address Valid to End of Write	t_{AW}	50		50		75		75		85		ns
Data Valid to End of Write	t_{DW}	30		40		45		50		50		ns
Write Pulse Width	t_{WP}	40		40		65		70		80		ns
Address Setup Time	t_{AS}	2		2		2		2		2		ns
Address Hold Time	t_{AH}	2		2		2		2		2		ns
Output Active from End of Write	t_{OW}[1]	5		10		10		10		10		ns
Write Enable to Output in High Z	t_{WHZ}[1]	0	30	0	40	0	45	0	50	0	50	ns
Data Hold Time	t_{DH}	1		0		0		0		0		ns

1. This parameter is guaranteed by design but not tested.

ORDERING INFORMATION



Device Type	Speed	Package	SMD No.
256K x 8 SRAM	120ns	32 pin DIP	5962-93157 01HXX
256K x 8 SRAM	100ns	32 pin DIP	5962-93157 02HXX
256K x 8 SRAM	85ns	32 pin DIP	5962-93157 03HXX
256K x 8 SRAM	70ns	32 pin DIP	5962-93157 04HXX
256K x 8 SRAM	55ns	32 pin DIP	5962-93157 05HXX